



# CCM PFC controller

**Datasheet** - **production data**



### **Features**

- Line-modulated fixed-off-time (LM-FOT) control of CCM-operated PFC pre-regulators
- Proprietary LM-FOT modulator for nearly fixedfrequency operation
- Proprietary multiplier design for minimum THD of AC input current
- Fast "bi-directional" input voltage feedforward  $(1/\sqrt{2})^2$  correction)
- Accurate adjustable output overvoltage protection
- Protection against feedback loop failure (latched shutdown)
- Inductor saturation protection
- AC brownout detection
- Digital leading-edge blanking on current sense
- Soft-start
- 1% (at Tj = 25 °C) internal reference voltage
- $\bullet$  600 / + 800 mA totem pole gate driver with active pull-down during UVLO and voltage clamp
- SSOP10 package

### **Applications**

- PFC pre-regulators for:
	- IEC61000-3-2 and JEIDA-MITI compliant SMPS in excess of 1 KW
	- Desktop PC, server, web server

**Table 1. Device summary**



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## **1 Description**

The L4984D is a current-mode PFC controller operating with line-modulated fixed-off-time (LM-FOT) control. A proprietary LM-FOT modulator allows fixed-frequency operation for boost PFC converters as long as they are operated in CCM (continuous conduction mode).

The chip comes in a 10-pin SO package and offers a low-cost solution for CCM-operated boost PFC pre-regulators in EN61000-3-2 and JEIDA-MITI compliant applications, in a power range that spans from few hundred W to 1 KW and above.

The highly linear multiplier includes a special circuit, able to reduce the crossover distortion of the AC input current, that allows wide-range-mains operation with a reasonably low THD, even over a large load range.

The output voltage is controlled by means of a voltage-mode error amplifier and an accurate (1% at T<sub>i</sub> = 25 °C) internal voltage reference. Loop stability is optimized by the voltage feedforward function ( $1/\sqrt{2}$  correction), which in this IC uses a proprietary technique that also significantly improves line transient response in the case of mains drops and surges ("bi-directional").

The device features low consumption and includes a disable function suitable for IC remote on/off. These features allow use in applications which also comply with the latest energy saving requirements (Blue Angel, ENERGY STAR®, Energy 2000, etc.).

In addition to overvoltage protection able to keep the output voltage under control during transient conditions, the IC is also provided with protection against feedback loop failures or erroneous settings. Other onboard protection functions allow that brownout conditions and boost inductor saturation can be safely handled. Soft-start limits peak current and extends off-time to prevent flux runaway in the initial cycles.

The totem pole output stage, capable of 600 mA source and 800 mA sink current, is suitable for big MOSFETs or IGBT drive.



# <span id="page-4-0"></span>**2 Block diagram**



**Figure 1. Electrical diagram**







**Figure 2. Pin connection (top view)** 



**Table 3. Thermal data**

















### **Table 4. Pin functions (continued)**

# <span id="page-8-0"></span>**3 Electrical characteristics**

(Tj = -25 to 125 °C,  $V_{CC}$  = 12 V,<sup>(a)</sup> CTIMER = 470 pF, Co = 1 nF between pin GD and GND,  $C_{FF}$  = 1 μF and R<sub>FF</sub> = 1 MΩ between pin VFF and GND; unless otherwise specified.)





a. Adjust  $V_{CC}$  above  $V_{CCOn}$  before setting at 12 V.













1. Parameters tracking each other.

2. The multiplier output is given by:

$$
V_{CS} = \mathrm{V_{CS,OS}} + K_{_M} \cdot \frac{V_{MULT}\left(V_{COMP}^{-2.5}\right)}{V_{VFF}^2}
$$



# <span id="page-11-0"></span>**4 Typical electrical performance**

<span id="page-11-4"></span><span id="page-11-3"></span><span id="page-11-2"></span><span id="page-11-1"></span>

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<span id="page-12-2"></span>

<span id="page-12-4"></span>



<span id="page-12-5"></span><span id="page-12-3"></span>VCOMP  $VCC = V$ 



ST

<span id="page-13-1"></span><span id="page-13-0"></span>

<span id="page-13-3"></span>AM13233v1

 $\frac{1}{T}$  (C) and the contract and the contract of the contra

<span id="page-13-2"></span>**Figure 19. FFD threshold vs. Tj**

<span id="page-13-4"></span>





<span id="page-14-1"></span><span id="page-14-0"></span>Figure 20. Multiplier characteristics at V<sub>FF</sub>=1 V Figure 21. Multiplier characteristics at V<sub>FF</sub>=3 V

<span id="page-14-4"></span>Figure 24. Gate drive output saturation vs. Tj Figure 25. Delay to output vs. Tj

-50 -25 0 25 50 75 100 125 150 175

Tj (C)

<span id="page-14-2"></span>0.2  $\Gamma$ 



<span id="page-14-5"></span>AM13238v1

<span id="page-14-3"></span>12.65

-50 -25 0 25 50 75 100 125 150 175

Tj (C)



AM13239v1

# <span id="page-15-0"></span>**5 Application information**

## <span id="page-15-1"></span>**5.1 Theory of operation**

The L4984D implements conventional "peak" current mode control, where the on-time TON of the external power switch is determined by the peak inductor current reaching the programmed value. The off-time TOFF, instead, is determined by a special fixed-off-time (FOT) modulator in such a way that the resulting switching period is constant as long as the boost converter is operated in CCM (i.e. the current in the boost inductor remains greater than zero in a switching cycle).

To understand how TOFF needs to be modulated to achieve a fixed switching frequency independent of the instantaneous line voltage and the load, it is useful to consider the V·s balance equation for the boost inductor under the assumption of CCM operation:

### **Equation 1**

$$
T_{_{ON}}\,\text{Vpk}\,\text{sin}\theta\text{=}\,T_{_{OFF}}\left(\text{Vout}-\text{Vpk}\,\text{sin}\theta\right)
$$

where Vpk is the peak line voltage, Vout the regulated output voltage and θ the instantaneous phase angle of the line voltage. Solving for TON, we get:

### **Equation 2**

$$
T_{\text{ON}} = \left(\frac{\text{Vout}}{\text{Vpk} \sin\theta} - 1\right) T_{\text{OFF}}
$$

then, the switching period  $T_{SW}$  is:

### **Equation 3**

$$
T_{\text{sw}} = T_{\text{ON}} + T_{\text{OFF}} = \left(\frac{\text{Vout}}{\text{Vpk} \sin{\theta}} - 1\right) \hspace{-0.5mm} T_{\text{OFF}} + T_{\text{OFF}} = \frac{\text{Vout}}{\text{Vpk} \sin{\theta}} T_{\text{OFF}}
$$

In the end, if  $T_{\text{OFF}}$  is changed proportionally to the instantaneous line voltage, i.e. if:

### **Equation 4**

$$
T_{\text{OFF}} = K_t Vpk \sin \theta
$$

then  ${\sf T}_{\sf SW}$  is equal to  ${\sf K}_{\sf t}{\sf \cdot V}_{\sf out}$  and, since  ${\sf V}_{\sf out}$  is regulated by the voltage loop, also  ${\sf T}_{\sf SW}$  (and  $f<sub>SW</sub> = 1/T<sub>SW</sub>$ ) is fixed. This result is based on the sole assumption that the instantaneous line voltage and the output load are such that the boost inductor operates in CCM.





<span id="page-16-0"></span>**Figure 26. Line-modulated fixed-off-time modulator: a) internal block diagram; b) key waveforms**



#### **Equation 5**

$$
V_{\text{MULT}} = K_{\text{P}} V \text{pk} \sin \theta
$$

where KP is the divider ratio of the resistors biasing the MULT pin. As a result:

#### **Equation 6**

$$
T_{\text{OFF}} = \frac{C_{\text{T}}}{I_{\text{TIMER}}} K_{\text{P}} \text{ Vpk} \sin \theta \rightarrow K_{\text{t}} = \frac{C_{\text{T}}}{I_{\text{TIMER}}} K_{\text{P}}
$$

and the switching frequency is:

#### **Equation 7**

$$
f_{\text{sw}} = \frac{1}{T_{\text{sw}}} = \frac{I_{\text{TIMER}}}{K_{\text{P}} C_{\text{T}} \text{ Vout}} = \frac{1}{K_{\text{t}} \text{ Vout}}
$$

The timing capacitor CT, therefore, is selected with the following design formula:

### **Equation 8**

$$
C_{T} = \frac{I_{\text{TIMER}}}{K_{P} \text{ Vout } f_{\text{sw}}}
$$

 $V_{\text{out}}$  and fsw are design specifications,  $K_{\text{P}}$  is chosen so that the voltage on the MULT pin is within the multiplier linearity range (0 to 3 V) and ITIMER is specified in *Section 3: Electrical characteristics*.



Along a line half-cycle, TOFF goes all the way from a minimum near the zero-crossing to a maximum on the sinusoid peak. It is important to check that the off-time occurring on the peak of the voltage sinusoid at minimum input voltage is greater then the minimum programmable value:

#### **Equation 9**

$$
T_{\text{OFFmin}} = \frac{C_{\text{T}}}{I_{\text{TIMER}}} K_{\text{P}} \text{ Vpk}_{\text{min}} > 1.45 \ \mu s
$$

This constraint limits the maximum programmable frequency at:

### **Equation 10**

$$
f_{\text{sw.max}} = 690 \frac{Vpk_{\text{min}}}{Vout} \text{ [kHz]}
$$

As the line RMS voltage is increased and/or the output load is decreased, the boost inductor current tends to become discontinuous starting from the region around the zero-crossings. As a result, the switching frequency is no lo[nger cons](#page-14-5)tant and tends to increase. However, the frequency rise is significantly lower as compared to that in a transition-mode (TM) operated boost PFC stage, as illustrated in *Figure 25*. The switching frequency can exceed fsw.max in the region where the inductor current is discontinuous.

<span id="page-17-0"></span>



In this example the voltage ripple appearing across the output capacitor Cout has been neglected. This ripple at twice the line frequency fL has peak amplitude ΔVout proportional to the output current Iout:

### **Equation 11**

$$
\Delta \text{Vout} = \frac{\text{Iout}}{4\pi f_{L} \text{Cout}}
$$

As a consequence, fsw is not exactly constant but is modulated at 2fL, which spreads the spectrum of the electrical noise injected back into the power line and facilitates the compliance with conducted EMI emission regulations. The relative frequency change due to the output voltage ripple is:



**Equation 12**

$$
\frac{\Delta f_{sw}}{f_{sw}} = \frac{\frac{\Delta Vout}{Vout}}{1 + \frac{\Delta Vout}{Vout}}
$$

<span id="page-18-0"></span>



As a result of the operation of the circuit in *Figure 26*, the current that the boost PFC pre[regulator d](#page-18-0)raws from the power line is not exactly sinusoidal but is affected by distortion that is lower as the current ripple in the boost inductor is smaller as compared to its peak value. *Figure 28* shows some theoretical waveforms, relevant to full load condition, in a line cycle at different input voltages.

In the diagram on the left-hand side the line (input) current waveform is shown for different line voltages, while on the right-hand side the envelope of the inductor current at minimum and maximum line voltage is shown.

The input current waveform relevant to Vin = 88  $V_{ac}$  shows no visible sign of distortion; the operation of the boost inductor is CCM throughout the entire line cycle as testified by the inductor current envelope. The brown waveform is relevant to Vin = 190  $V_{\text{ac}}$ , which is the condition where CCM operation no longer occurs at zero-crossings (this voltage value, for a given power level, depends on the inductance value of the boost inductor); a certain degree of distortion is already visible.

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<span id="page-19-0"></span>**Figure 29. Line-modulated fixed-off-time-controlled boost PFC: input current harmonic contents** 

The waveform relevant to Vin = 264  $V_{ac}$  shows t[he highest](#page-19-0) degree of distortion and the largest portion of the line cycle where boost inductor operates in discontinuous mode (DCM). However, its harmonic content, shown in *Figure 29*, is still so low that it is not an issue for EMC compliance. Almost all the distortion is concentrated in the third harmonic, whose amplitude is 17% of the fundamental one, while the THD is 17.7%.



## <span id="page-20-0"></span>**6 Overvoltage protection (OVP)**

Normally, the voltage control loop keeps the output voltage Vout of the PFC pre-regulator close to its nominal value, set by the ratio of th[e resistors](#page-20-1) R1 and R2 of the output divider. A pin of the device (PFC\_OK) has been dedicated to monitor the output voltage with a separate resistor divider (R3 high, R4 low, see *Figure 30*). This divider is selected so that the voltage at the pin reaches 2.5 V if the output voltage exceeds a preset value, usually larger than the maximum Vout that can be expected.

AM13246v1 Frequency . . . . . . . . . . 2.5 V + - 0.23 V 0.27 V -  $+$ INV Disable OVP Error Amplifier COM 2.5 V 2.4 V + -  $1.66$ L\_OVP 6 1 2 - + PFC\_OK Vout R1a R1b R: R3a R3b R4 R3 R1 L4984D

<span id="page-20-1"></span>**Figure 30. Output voltage setting, OVP and FFD functions: internal block diagram** 

*Note: Example:*  $V_{out} = 400$  *V,*  $V_{outx} = 434$  *V. Select: R3 = 8.8 M; then: R4 = 8.8 M ·2.5/(434-2.5) = 51 k.*

> When this function is triggered, the gate drive activity is immediately stopped until the voltage on the pin PFC\_OK drops below 2.4 V. Notice that R1, R2, R3 and R4 can be selected without any constraints. The unique criterion is that both dividers must sink a current from the output bus which needs to be significantly higher than the bias current of both pins INV and PFC OK  $(< 1 \mu A)$ .

# <span id="page-21-0"></span>**7 Feedback failure detection (FFD)**

The OVP function handles "normal" overvoltage conditions, i.e. those resulting from an abrupt load/line change or occurring at startup. If the overvoltage is generated by a feedback failure, for instance when the upper resistor of the output divider (R1) fails open, eventually the error amplifier output (COMP) saturates high and the voltage on its inverting input (INV) drops from its steady-sate value (2.5 V). An additional comparator monitors the voltage on the INV pin, comparing it against a reference located at 1.66 V. When the voltage on pin PFC\_OK exceeds 2.5 V and, simultaneously, that on the INV pin falls below 1.66 V, the FFD function is triggered: the gate drive activity is immediately stopped, the device is shut down and its quiescent consumption reduced. This condition is latched and to restart the IC it is necessary to recycle the input power, so that the  $V_{CC}$  voltage goes below 6 V. The pin PFC\_OK doubles its function as a not-latched IC disable: a voltage below 0.23 V shuts down the IC, reducing its consumption below 2 mA. To restart, simply let the voltage on the pin go above 0.27 V. Note that these functions offer complete protection against not only feedback loop failures or erroneous settings, but also against a failure of the protection itself. Either resistor of the PFC\_OK divider failing short or open or a pin PFC\_OK floating results in shutting down the IC and stopping the pre-regulator.



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### <span id="page-22-0"></span>**8 Voltage feedforward**

The power stage gain of PFC pre-regulators varies with the square of the RMS input voltage. So does the crossover frequency fc of the overall open-loop gain because the gain has a single pole characteristic. This leads to large trade-offs in the design.

For example, setting the gain of the error amplifier to get fc = 20 Hz at 264  $V_{ac}$  means having fc = 4 Hz at 88  $V_{\text{ac}}$ , resulting in a sluggish control dynamics. Additionally, the slow control loop causes large transient current flow during rapid line or load changes that are limited by the dynamics of the multiplier output. This limit is considered when selecting the sense resistor to let the full load power pass under minimum line voltage conditions, with some margin. But a fixed current limit allows excessive power input at high line, whereas a fixed power limit requires the current limit to vary inversely with the line voltage.

Input voltage feedforward compensates for the gain variation with the line voltage and allows all of the above-mentioned issues to be minimized. It consists of deriving a voltage proportional to the input RMS voltage, feeding t[his voltage](#page-22-1) into a squarer/divider circuit (1/V2 corrector) and providing the resulting signal to the multiplier that generates the current reference for the inner current control loop (see *Figure 31*).

<span id="page-22-1"></span>



In this way, if the line voltage doubles the amplitude of the multiplier, output is halved and vice versa, so that the current reference is adapted to the new operating conditions with (ideally) no need to invoke the slow response of the error amplifier. Additionally, the loop gain is constant throughout the input voltage range, which improves significantly dynamic behavior at low line and simplifies loop design.

Actually, deriving a voltage proportional to the RMS line voltage implies a form of integration, which has its own time constant. If it is too small, the voltage generated is affected by a considerable amount of ripple at twice the mains frequency that causes distortion of the current reference (resulting in high THD and poor PF); if it is too large there is a considerable delay in setting the right amount of feedforward, resulting in excessive overshoot and undershoot of the pre-regulator output voltage in response to large line voltage changes. Clearly, a trade-off is required.

The L4984D realizes a new voltage feedforward that, using just two external parts, strongly minimizes this time constant trade-off issue whichever voltage change occurs on the mains,



both surges and drops. A capacitor  $C_{FF}$  and a resistor  $R_{FF}$ , connected from the VFF pin to ground, complete an internal peak-holding circuit that provides a DC voltage equal to the peak of the voltage applied on the MULT pin. In this way, in case of sudden line voltage rise,  $C_{FE}$  is rapidly charged through the low impedance of the internal diode; in case of line voltage drop, an internal "mains drop" detector enables a low impedance switch that suddenly discharges  $C_{FE}$ , therefore reducing the settling time needed to reach the new voltage level. The discharge of  $C_{FF}$  is stopped when either its voltage equals the voltage on [the MULT pin or the voltage](#page-29-0) on the VFF pin falls below 0.88 V, to prevent the "brownout protection" function from being improperly activated (see *Section 12: Power management and housekeeping functions*). With this functionality, an acceptably low steady-state ripple of the VFF voltage (and, then, low current distortion) can be achieved with a limited undershoot or overshoot on the pre-regulator output during line transients.

The twice-mains-frequency (2⋅ fL) ripple appearing across  $C_{FF}$  is triangular with peak-topeak amplitude that, with good approximation, is given by:

#### **Equation 13**

$$
\Delta V_{FF} = \frac{2 V_{\text{MULTpk}}}{1 + 4 f_{L} R_{FF} C_{FF}}
$$

where fL is the line frequency. The amount of 3rd harmonic distortion introduced by this ripple, related to the amplitude of its 2⋅ fL component, is:

#### **Equation 14**

$$
D_{3}\% = \frac{100}{2\pi f_{L}R_{FF}C_{FF}}
$$

*Figure 32* shows a diagram that helps choose the time constant  $R_{FF}$  C<sub>FF</sub> based on the amount of maximum desired 3rd harmonic distortion. Note, however, that there is a minimum value for the time constant  $R_{FF}C_{FF}$  below which improper activation of the VFF fast discharge may occur. In fact, the twice-mains-frequency ripple across  $C_{FF}$  under steady-state conditions must be lower than the minimum line drop detection threshold  $(\Delta V_{VFF,min} = 40 \text{ mV})$ . Therefore:

#### **Equation 15**

$$
R_{\text{FF}}\cdot C_{\text{FF}} > \frac{2\frac{V_{\text{MULTpk\_max}}}{\Delta V_{\text{VFF\_min}}}-1}{4\,f_{\text{L\_min}}}
$$

Always connect  $R_{FF}$  and  $C_{FF}$  to the pin; the IC does not work properly if the pin is left floating or may be damaged if connected directly to ground.





<span id="page-24-0"></span>Figure 32. R<sub>FF</sub>·C<sub>FF</sub> as a function of 3rd harmonic distortion introduced in the input **current**



### <span id="page-25-0"></span>**9 Soft-start**

[To reduce](#page-29-0) inrush energy at startup or after an auto-restart protection tripping, the L4984D uses soft-start. Please refer to *Table* in *Section 12: Power management and housekeeping functions* for more details of the events triggering soft-start.

The function is performed by internally pulling the voltage on the MULT pin towards an asymptotic level located at about 4.1 V as the device wakes up. This has a twofold effect: on the one hand, the output of the multiplier is lowered through the voltage feedforward function, therefore programming a lower peak current; on the other hand, the off-time of the power switch is considerably prolonged with respect to the normal values programmed by the capacitor connected to the TIMER pin. In this way, both the current inrush and the risk of saturating the boost inductor at startup are minimized.

After 300 μs from its activation, the pull-up is released. The voltage on the MULT pin decays with the time constant determined by the resistor divider that biases the pin and the bypass capa[citor typically connected betwee](#page-22-0)n the pin and ground to reduce noise pick-up. At the same time,  $C_{FF}$  is discharged by turning on the internal low impedance discharge switch (see *Section 8: Voltage feedforward*).

The soft-start function is performed at turn-on by VCC Turn-on threshold ( $V_{CCOn}$ ), by the brownout funct[ion and at](#page-25-1) startup by PFC\_OK. On the following activations by PFC\_OK (like during burst-mode operation driven by a D2D converter controller) the soft-start function is not performed. *Figure 33* shows the different startup mechanisms and the activations of the soft-start function.

<span id="page-25-1"></span>

**Figure 33. Startup mechanisms and activations of the soft-start function**



## <span id="page-26-0"></span>**10 Inductor saturation detection**

Boost inductor hard saturation may be a fatal event for a PFC pre-regulator: the current upslope becomes so large (50-100 times steeper, see *Figure 34*) that, during the current sense propagation delay, the current may reach abnormally high values. The voltage drop caused by this abnormal current on the sense resistor reduces the gate-to-source voltage, so that the MOSFET may work in the active region and dissipate a huge amount of power, which leads to a catastrophic failure after few switching cycles.

However, even a well-designed boost inductor may occasionally saturate when the boost stage recovers after a missing line cycle. This happens when the restart occurs at an unfavorable line voltage phase, i.e. when the output voltage is lower than the rectified input voltage as this reappears. As a result, in the boost inductor the inrush current coming from the bridge rectifier and going to the output capacitor adds up to the switched current. Furthermore, there is little or no voltage available for demagnetization.

To cope with a saturated inductor, the L4984D is provided with a second comparator on the current sense pin (CS, pin 4) that stops the IC if the voltage, normally limited within 0.88 V, exceeds 1.7 V. After that, the IC is restarted by the internal starter circuitry; the starter repetition time is low enough (300 μs typ.) to guarantee low stress for the inductor, the Power MOSFET and the boost diode.

<span id="page-26-1"></span>



# <span id="page-27-0"></span>**11 THD optimizer circuit**

The L4984D is provided with a special circuit that reduces the conduction dead-angle occurring at the AC input current near the zero-crossings of the line voltage (crossover distortion). In this way the THD (total harmonic distortion) of the current is considerably reduced.

A major cause of this distortion is the inability of the system to transfer energy effectively when the instantaneous line voltage is very low. This effect is magnified by the highfrequency filter capacitor placed after the bridge rectifier, which retains some residual voltage that causes the diodes of the bridge rectifier to be reverse-biased and the input current flow to temporarily stop.

To overcome this issue the device forces the PFC pre-regulator to process more energy near the line voltage zero-crossings as compared to that commanded by the control loop. This results in both minimizing the time interval where energy transfer is lacking and fully discharging the high-frequency filter capacitor after the bridge.

<span id="page-27-1"></span>

**Figure 35. THD optimizer circuit**





<span id="page-28-0"></span>

**Figure 36. HD optimization: standard PFC controller**



To take maximum benefit from the THD optimizer circuit, the high-frequency filter capacitor after the bridge rectifier should be minimized, compatibly with EMI filtering needs. A large capacitance, in fact, introduces a conduction dead-angle of the AC input current - even with an ideal energy transfer by the PFC pre-regulator - therefore reducing the effectiveness of the optimizer circuit.

Essentially, the circuit artificially increases the on-time of the power switch with a positive offset added to the output of the multiplier in the proximity of the line voltage zero-crossings. This offset is reduced as the instantaneous li[ne voltage increases, so that it b](#page-22-0)ecomes negligible as the line voltage moves toward the top of the sinusoid. Furthermore, the offset is modulated by the voltage on the VFF pin (see *Section 8: Voltage feedforward*) so as to have little offset at low line, where energ[y transfer a](#page-28-0)t zero-crossings is typically quite good, and a larger offset at high line where the energy transfer gets worse.

The effect of the circuit is shown in *Figure 36*, where the key waveforms of a standard PFC controller are compared to those of this chip. Note the significant reduction in the region around the zero-crossing where the drain voltage cannot reach the output voltage and how switching frequency drops dramatically near the zero-crossing.



### <span id="page-29-0"></span>**12 Power management and housekeeping functions**

[A communication line w](#page-21-0)ith the control IC of the cascaded DC-DC converter can be established via the disable function included in the PFC\_OK pin (see *Section 7: Feedback failure detection (FFD)* for more details). Typically this line is used to allow the PWM controller of the cascaded DC-DC converter to shut down the L4984D in case of light load and to minimi[ze the no-](#page-29-1)load input consumption. Should the residual consumption of the chip be an issue, it is also possible to cut down the supply voltage. Interface circuits like those are shown in *Figure 37*. Needless to say, this operation assumes that the cascaded DC-DC converter stage works as the master and the PFC stage as the slave or, in other words, that the DC-DC stage starts first; it powers both controllers and enables/disables the operation of the PFC stage.



### <span id="page-29-1"></span>**Figure 37. Interface circuits that let DC-DC converter controller IC disable the L4984D**

Another available function is brownout protection, which is basically a not-latched shutdown function that is activated when a condition of mains undervoltage is detected. This condition may cause overheating of the primary power section due to an excess of RMS current. Brownout can also cause the PFC pre-regulator to work in open loop, which may be dangerous to the PFC stage itself and the downstream converter, should the input voltage return abruptly to its rated value. Another problem is the spurious restarts that may occur during converter power-down and that cause the output voltage of the converter to not decay to zero monotonically. For these reasons it is usually preferable to shut down the unit in the case of brownout. The brownout threshold is internally fixed at 0.8 V and is sensed on the VFF pin while the voltage is falling. An 80 mV hysteresis prevents rebounding at input voltage turn-off.

The soft-star[t function](#page-25-1) is performed by PFC\_OK enable threshold ( $V_{\text{PFC\_OK}-E}$ ) only at startup, but not on the following activations, to ensure a proper burst-mode operation (as d[escribed](#page-30-0) in *Figure 33*). For this reason pin MULT is suggested to be used as remote ON/OFF control.

In *Table 6* it is possible to find a summary of all of the above mentioned working conditions that cause the device to stop operating.



<span id="page-30-0"></span>

<b>Condition</b>	Caused or revealed by	<b>IC</b> behavior	<b>Restart</b> condition	<b>Typical IC</b> consumption	SS activation
<b>UVLO</b>	$V_{CC}$ < $V_{CCOff}$	Disabled	$V_{CC}$ > $V_{CCOn}$	$65 \mu A$	Yes
Standby	VPFC OK < VPFC_OK_D	Stop switching	$V_{PFC_OK}$ V <sub>PFC_OK_E</sub>	1.5 mA	No.
AC brownout	$V_{VFF}$ < $V_{DIS}$	Stop switching	$V_{VFF}$ > $V_{EN}$	$1.5 \text{ mA}$	Yes
<b>OVP</b>	$V_{PFC_OK}$ > $V_{PFC_OK_S}$	Stop switching	$V_{PFC_OK}$ V <sub>PFC_OK_R</sub>	$2.2 \text{ mA}$	No.
Feedback failure	$V_{PFCOK}$ > $V_{PFCOKS}$ AND $V_{\text{INV}}$ < 1.66 V	Latched-off	$V_{CC}$ < $V_{CCrestart}$ then $V_{CC}$ > $V_{CCOn}$	180 µA	Yes
Low consumption	$V_{\text{COMP}}$ < 2.4 V	Burst mode	$VCOMP$ > 2.4 V	$1.8 \text{ mA}$	No
Saturated boost inductor	$Vcs > V_{CS_th}$	Stop switching	Auto restart after 300 is	4 mA	No

**Table 6. Summary of L4984D idle states**



# <span id="page-31-0"></span>**13 Package mechanical data**

In order to meet environmental requirements, ST offers these devic[es in different](http://www.st.com) grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK is an ST trademark.







<span id="page-32-0"></span>

**Figure 38. SSO10 package dimensions**



# <span id="page-33-0"></span>**14 Revision history**







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